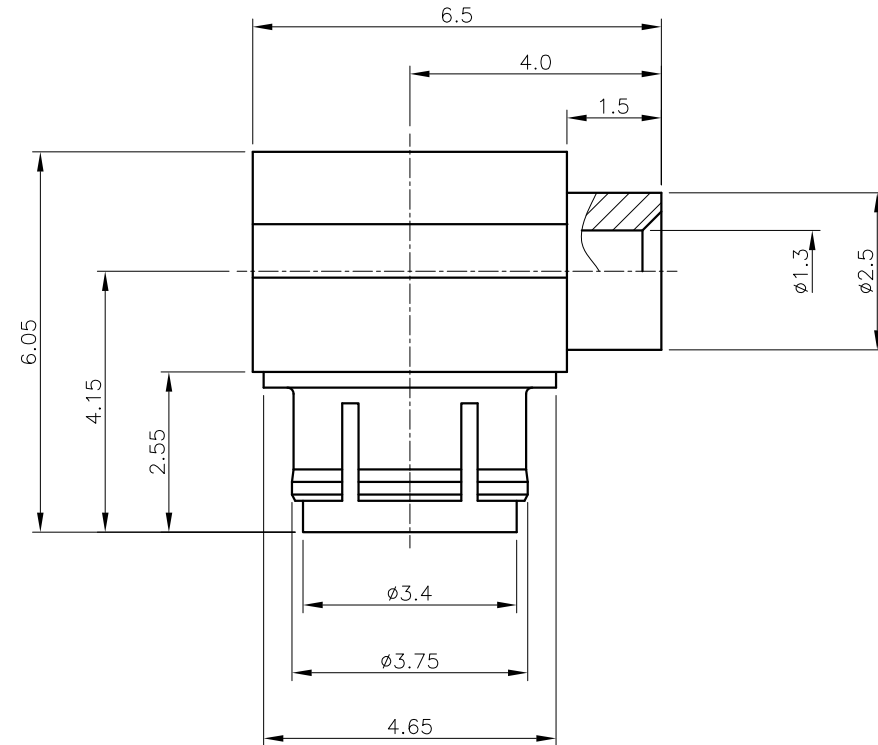
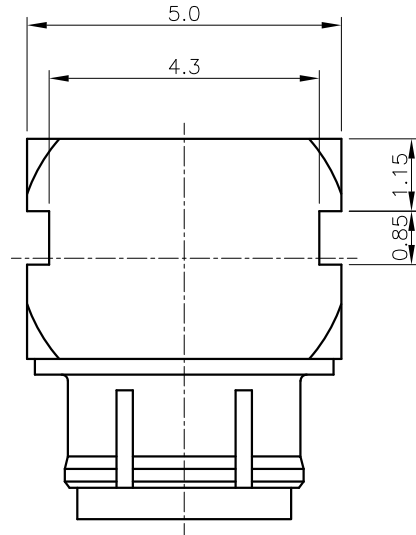
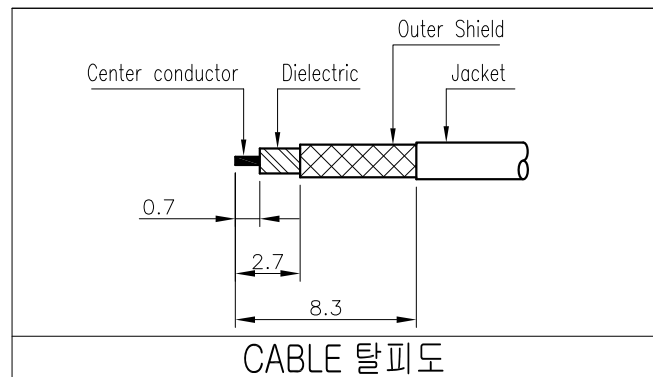


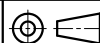
REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.H.KIM		2022.10.18.
i	JACK 바디 및 핀 구성 변경- 삽/이탈력 개선	S.H.KIM		2023.05.11.



- ▶ MMBX50 Female 상대물 메이팅 검사 진행할 것
- 삽입력 : 3.05kgf (Max)
 - 이탈력 : 0.8~3.05kgf



4	COVER	1	MBsBD C3604BD-F	Gold Plate	DCO00013-5/5
3	INSULATOR	1	TEFLON		DIN02475-N/2
2	CONTACT	1	BeCu C17300	Gold Plate	DCT04334-5/2 DCT04334-5/1
1-2	JACK BODY	1	BeCu C17300	Gold Plate	DBD03743-4/2 DBD03743-4/3
1-1	BODY	1	MBsBD C3604BD-F	Gold Plate	DBB00521-5/1 DBB00521-5/2 DBD04862-1/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.2	DATE 2023. 05. 11.			 COMTECH KJ COMTECH CO.,LTD.	RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017	
	Angle ±1°	APPROVED BY					
MATERIAL -		CHECKED BY			TITLE MMBX50 CABLE PL 47		
		DRAWN BY S.H.KIM					
FINISH -		SCALE 8/1	UNIT mm		A4	DWG NO. CN04068-7/1	
						REVISION 1	SHEET 1 of 1